

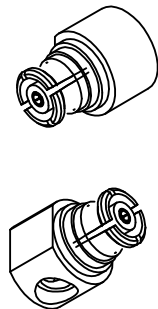
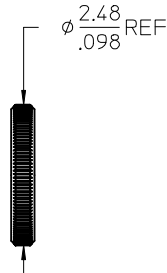
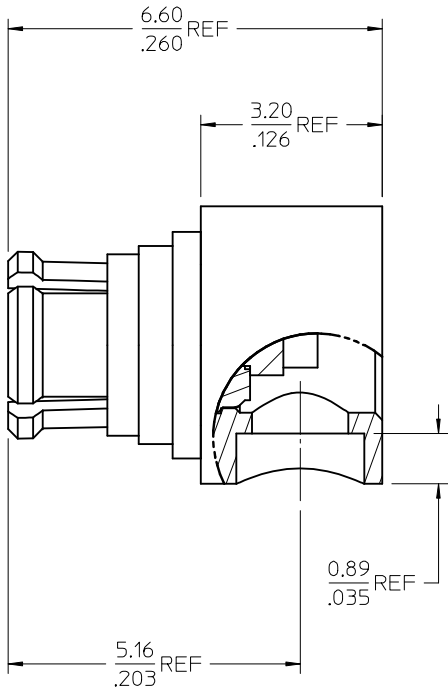
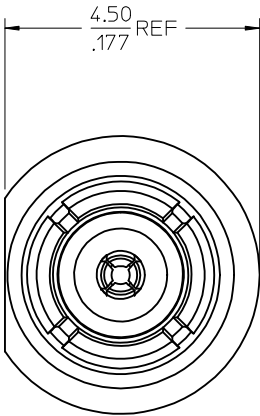
MATERIALS AND FINISHES

BODY: BERYLLIUM COPPER
PLATED GOLD

CONTACT: BERYLLIUM COPPER
PLATED GOLD

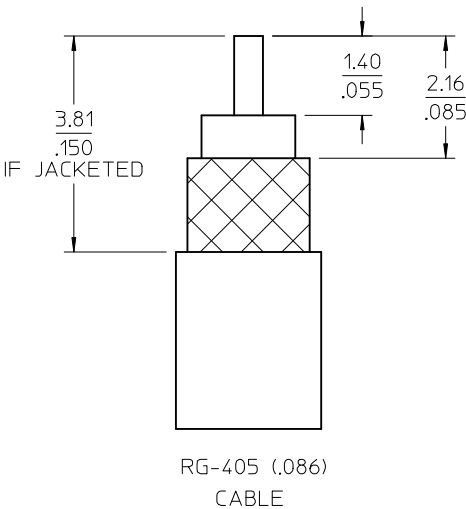
INSULATOR: TEFLON

EMI RING, CAP: BRASS
PLATED GOLD



MIL-STD-348A, FIG. 326.1	INTERFACE
SPECIFICATION	DESCRIPTION

73415-3035	MOLEX INTERNAL USE ONLY NOT AVAILABLE	N/A	N/A	N/A
73415-3034	BULK PACK	30 u"	30 u"	30 u"
73415-3033	BULK PACK	8 u"	8 u"	8 u"
73415-3032	PLACE 73415-3030 INTO SMALL TRAY	30 u"	50 u"	30 u"
73415-3031	1 COMPLETE ASSEMBLY 73415-3030 PER BAG	30 u"	50 u"	30 u"
73415-3030	BULK PACK	30 u"	50 u"	30 u"
PART NO.	PACKAGING	GOLD ON BODY	GOLD ON CONT	GOLD RING/CAP



CHG: UPDATE VIEW

EC NO: URF2013-0460

DRWN: JWIENER

CHKD: SSS

APPR: JWIENER

REV

2013/02/08

2013/02/08

2013/02/11

DESCRIPTION

QUALITY SYMBOLS

▽=0

▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± .005	± .0004
3 PLACES	± .005	± .0004
2 PLACES	± .005	± .0004
1 PLACE	± .005	± .0004

ANGULAR ± 2 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE

MM/IN

DRAWN BY

DATE

CHECKED BY

DATE

APPROVED BY

DATE

MATERIAL NO.

SEE TABLE

SIZE

C

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE PROJECTION

TITLE

SMP JACK, R/A FOR 086 CABLE, 50 OHM SMP-JC

MOLEX INCORPORATED

SD-73415-303

1 OF 1

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